

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number:

5015912411

Status:

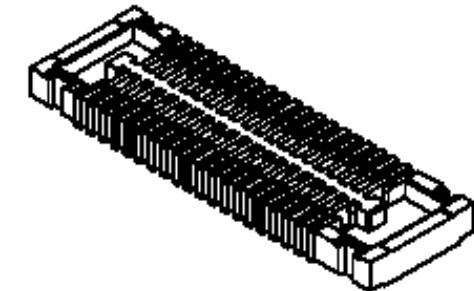
Active

Overview:

slimstack_mm016_pitch

Description:

0.40mm (.016") Pitch SlimStack™ Board-to-Board Receptacle, SMT, Dual Row, Vertical Stacking, 0.90mm (.035") Stacking Height, With Solder Tabs, 24 Circuits



Series

image - Reference only

Documents:

- [3D Model](#)
- [Drawing \(PDF\)](#)
- [Product Specification PS-501591-002 \(PDF\)](#)
- [Product Specification PS-501591-003 \(PDF\)](#)
- [RoHS Certificate of Compliance \(PDF\)](#)

General

Product Family	PCB Receptacles
Series	501591
Application	Board-to-Board
Overview	slimstack_mm016_pitch
Product Name	SlimStack™

Physical

Circuits (Loaded)	24
Color - Resin	Black
Durability (mating cycles max)	20
Glow-Wire Compliant	No
Lock to Mating Part	Yes
Mated Height (in)	0.035 In
Mated Height (mm)	0.90 mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Number of Rows	2
Orientation	Vertical
PCB Locator	No
PCB Retention	Yes
Packaging Type	Embossed Tape on Reel
Pitch - Mating Interface (in)	0.016 In
Pitch - Mating Interface (mm)	0.40 mm
Polarized to Mating Part	No
Polarized to PCB	No
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-25°C to +85°C
Termination Interface: Style	Surface Mount

Electrical

Current - Maximum per Contact	0.3A
Voltage - Maximum	50V AC (RMS)/DC

Material Info

Reference - Drawing Numbers

Packaging Specification	SPK-501591-001
Product Specification	PS-501591-002, PS-501591-003, RPS-501591-007, RPS-501591-010, RPS-501591-011, RPS-501591-012, RPS-501591-013, RPS-501591-014, RPS-501591-015, RPS-501591-016, RPS-501591-017, RPS-501591-019, RPS-501591-020
Sales Drawing	SD-501591-005, SD-501591-006

EU RoHS

ELV and RoHS
Compliant
REACH SVHC
Not Reviewed
Halogen-Free
Status

China RoHS



Need more information on product
environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

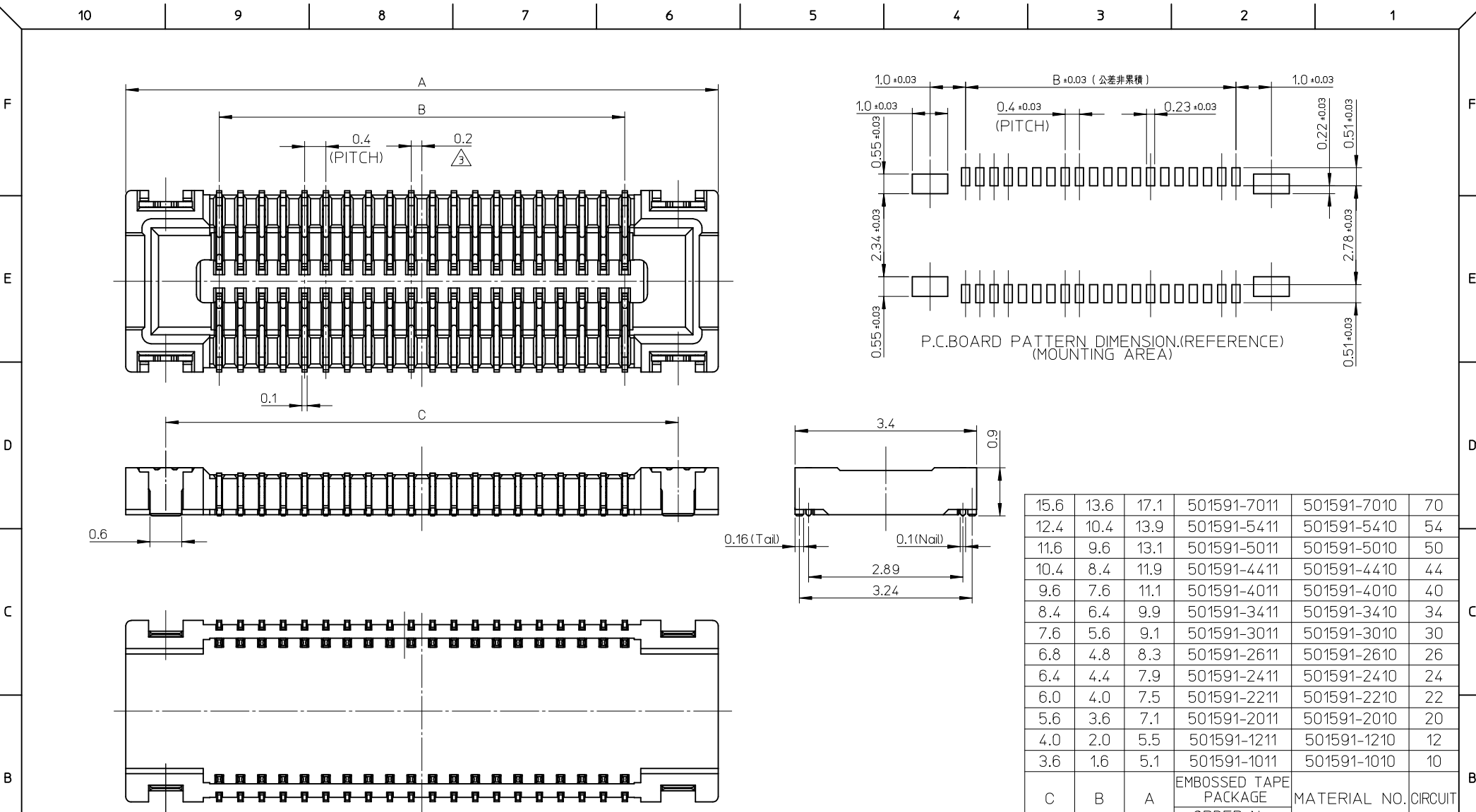
Please visit the [Contact Us](#) section for any
non-product compliance questions.

Search Parts in this Series
501591Series

Mates With
501594 PCB Header

This document was generated on 05/24/2010

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION



15.6	13.6	17.1	501591-7011	501591-7010	70
12.4	10.4	13.9	501591-5411	501591-5410	54
11.6	9.6	13.1	501591-5011	501591-5010	50
10.4	8.4	11.9	501591-4411	501591-4410	44
9.6	7.6	11.1	501591-4011	501591-4010	40
8.4	6.4	9.9	501591-3411	501591-3410	34
7.6	5.6	9.1	501591-3011	501591-3010	30
6.8	4.8	8.3	501591-2611	501591-2610	26
6.4	4.4	7.9	501591-2411	501591-2410	24
6.0	4.0	7.5	501591-2211	501591-2210	22
5.6	3.6	7.1	501591-2011	501591-2010	20
4.0	2.0	5.5	501591-1211	501591-1210	12
3.6	1.6	5.1	501591-1011	501591-1010	10
C	B	A	EMBOSSD TAPE PACKAGE	MATERIAL NO.	CIRCUIT
			ORDER No.		

REVISED EC NO: J2008-3370 DRWN:KSE10 CHKD:MSASAO APPR:MSASAO REV	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY TASAKAWA	DATE 2006/07/10	TITLE 0.4MM PITCH B/B CONN. H=0.9 W=3.4 REC ASSY				
		10 OVER 30 UNDER	± 0.25	CHECKED BY MSASAO	DATE 2006/07/10					
		30 OVER	± 0.3	APPROVED BY MSASAO	DATE 2006/07/10	MOLEX MOLEX INCORPORATED				
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.				SHEET NO.
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		SEE TABLE		SD-501591-005 1 OF 2			
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION										

注記 NOTES

1.使用材料
MATERIAL

ハウジング：液晶ポリマー（LCP） ガラス充填 UL-94V-0（黒）
HOSING：LIQUID CRYSTAL POLYMER (GLASS FILLED) UL94V-0 (COLOR:BLACK)

ターミナル：りん青銅（ $t=0.1$ ）
TERMINAL：PHOSHOR BRONZE ($t=0.1$)

金具：りん青銅（ $t=0.1$ ）
FITTING NAIL：PHOSHOR BRONZE ($t=0.1$)

2.メッキ仕様
PLATING

ターミナル
TERMINAL

金メッキ 0.1マイクロメートル以上（コンタクト部）
GOLD 0.1 MICROMETER MINIMUM (CONTACT AERA)

金メッキ 0.05マイクロメートル以上（テール部）
GOLD 0.05 MICROMETER MINIMUM (TAIL AERA)

下地メッキ：ニッケルメッキ 1.0 マイクロメートル以上
UNDER PLATING：NICKEL 1.0 MICROMETER MINIMUM

金具

FITTING NAIL

錫メッキ：1.0マイクロメートル以上
TIN PLATING：1.0 MICROMETER MINIMUM

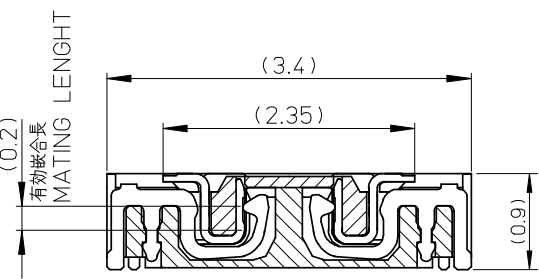
下地メッキ：ニッケル 1.0マイクロメートル以上
UNDER PLATING：NICKEL 1.0 MICROMETER MINIMUM

△3（全極数/2）=偶数の場合に適用
APPLY FOR (CIRCUIT/2)=EVEN

4.嵌合相手：501594-**10シリーズ
WITH MATE：501594-**10SERIES

5.テール及び金具の平坦度は、0.1以下
TAIL AND FITTING NAIL COPLANARITY TO BE 0.1 MAXIMUM

6.ELV AND RoHS COMPLIANT.



嵌合断面図 (参考)
MATED DRAWING

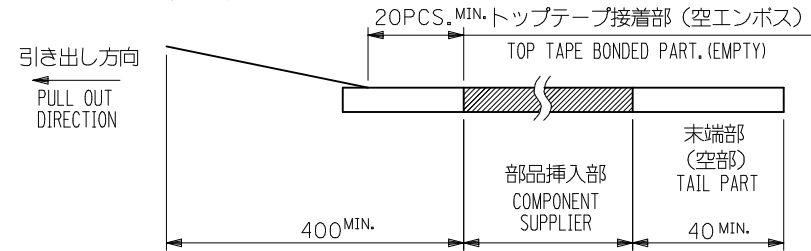
REVISED EC NO: J2008-3370 DRAWN:KSETO 2008/06/17 CHKD:MSASAO 2008/06/17 APPR:MSASAO 2008/06/25 T	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY TASAKAWA	DATE 2006/07/10	TITLE 0.4MM PITCH B/B CONN. H=0.9 W=3.4 REC ASSY				
		10 OVER 30 UNDER	± 0.25	CHECKED BY MSASAO	DATE 2006/07/10					
		30 OVER	± 0.3	APPROVED BY MSASAO	DATE 2006/07/10	MOLEX MOLEX INCORPORATED				
		ANGULAR ±3 °		MATERIAL NO. SEE SHEET 1		DOCUMENT NO. SD-501591-005		SHEET NO. 2 OF 2		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						
				SIZE A3						

NOTES

1. 製品詳細寸法については製品単体図面を参照下さい。
RE DETAILED DIMENSION, SEE PRODUCT DRAWING.

2. 梱包数量： 3000 個／リール
NUMBER OF CONNECTORS : 3000 PCS/REEL

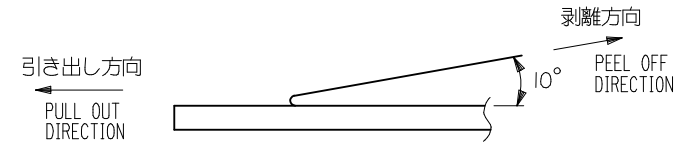
3. リードテープ長さ LEAD TAPE LENGTH



4. トップテープの剥離強度： JES-59 参照

剥離方向は下図参照。

PEELING OFF STRENGTH OF TOP TAPE : REFER TO JES-59
PEELING DIRECTION AS SHOWN IN FOLLOWING FIGURE.



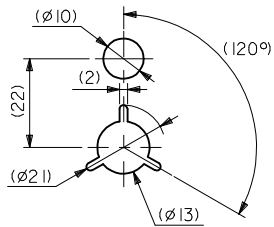
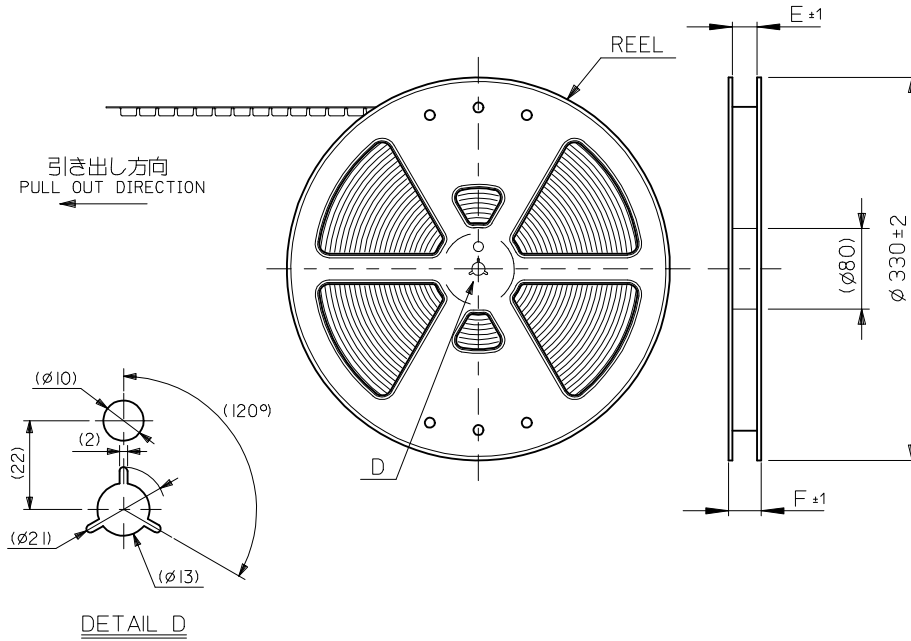
5. 材料 MATERIAL

キャリアテープ (CARRIER TAPE)：ポリスチレン (POLYSTYLENE)

トップテープ (TOPTAPE)： PET , PE , PEF

リール (REEL)： ポリスチレン (PS) <リサイクル材を含む>
POLYSTYLENE (PS) <RECYCLE MATERIAL CONTAINED>

6.ELV AND RoHS COMPLIANT.



DETAIL D

REVISED	EC NO: J2008-3370	2008/06/17	DRWN:KSETO	2008/06/17	CHKD:MSASAO	2008/06/25	APPR:MSASAO	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
									10 UNDER	± 0.2	DRAWN BY TASAKAWA	DATE 2006/07/10	TITLE 0.4 B-TO-B CONN. REC ASSY (HGT=0.9) EMBSTP PKG			
									10 OVER 30 UNDER	± 0.25	CHECKED BY MSASAO	DATE 2006/07/10				
									30 OVER	± 0.3	APPROVED BY MSASAO	DATE 2006/07/10	MOLEX INCORPORATED			
									ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
									DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 1		SD-501591-006		1 OF 2	
									REV			SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

10

9

8

7

6

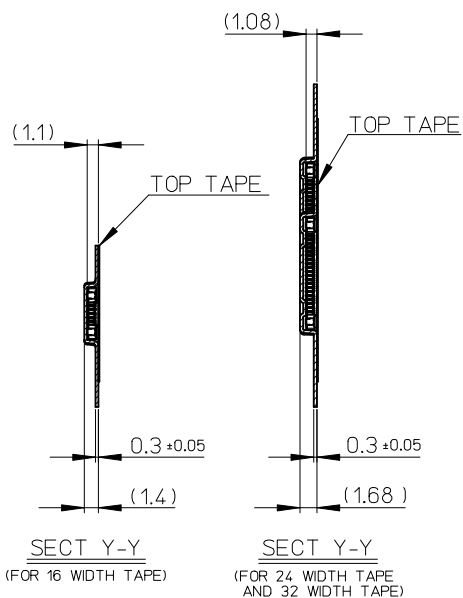
5

4

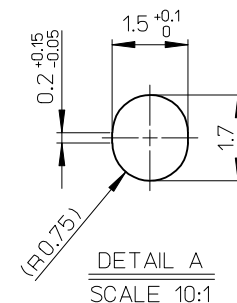
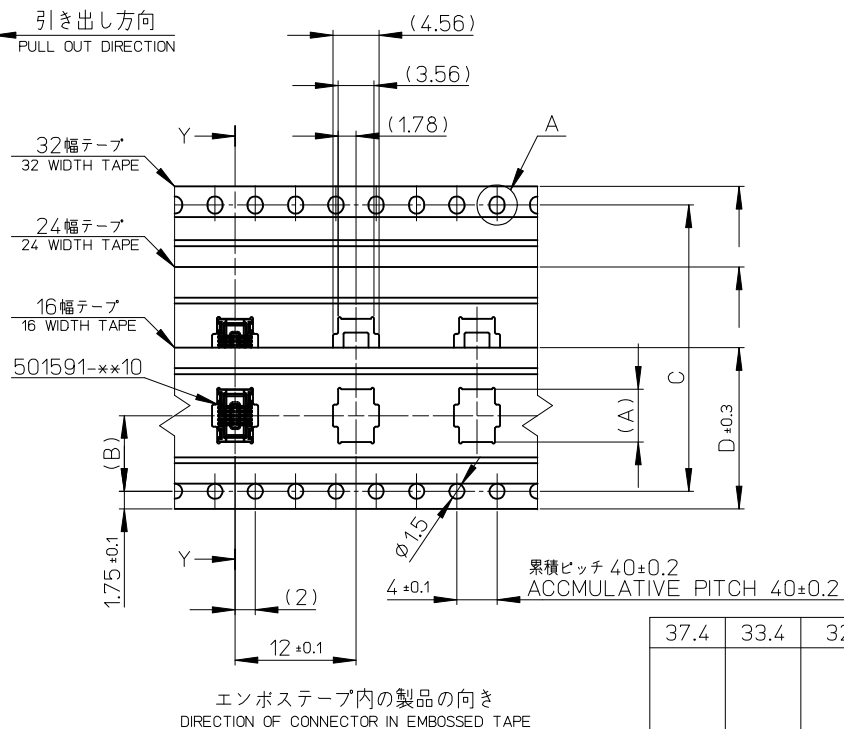
3

2

1



引き出し方向
PULL OUT DIRECTION



37.4	33.4	32	28.4	14.2	17.26	501591-7011	70
29.4	25.4	24	——	11.5	14.06	501591-5411	54
					13.26	501591-5011	50
					12.06	501591-4411	44
					11.26	501591-4011	40
					10.06	501591-3411	34
					9.26	501591-3011	30
					8.46	501591-2611	26
					8.06	501591-2411	24
					7.66	501591-2211	22
21.4	17.4	16	——	7.5	7.26	501591-2011	20
					5.66	501591-1211	12
					5.26	501591-1011	10
F	E	D	C	(B)	(A)	MATERIAL No.	極数 CK

REVISED EC NO: J2008-3370 2008/06/17 DRAWN:SETO 2008/06/17 CHKD:MSASAO 2008/06/25 APPR:MSASAO	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC		THIRD ANGLE PROJECTION
		10 UNDER	± 0.2	DRAWN BY TASAKAWA	DATE 2006/07/10	TITLE 0.4 B-TO-B CONN. REC ASSY (HGT=0.9) EMBSTP PKG			
		10 OVER 30 UNDER	± 0.25	CHECKED BY MSASAO	DATE 2006/07/10				
		30 OVER	± 0.3	APPROVED BY MSASAO	DATE 2006/07/10	 MOLEX INCORPORATED			
		ANGULAR ±3 °		MATERIAL NO.					
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		SEE TABLE		SD-501591-006	

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									
--	--	--	--	--	--	--	--	--	--

9

8

7

6

5

4

3

2

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9